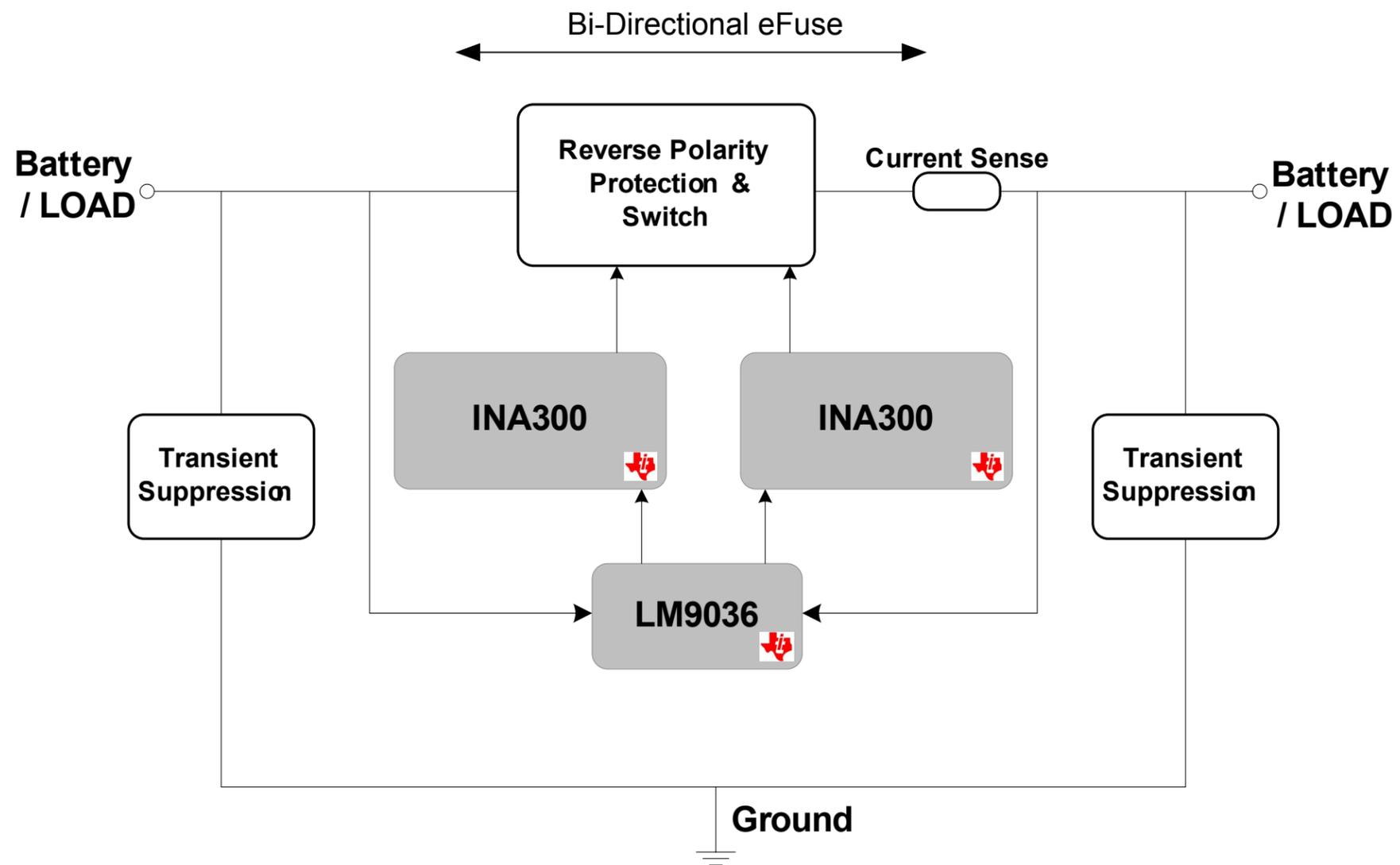
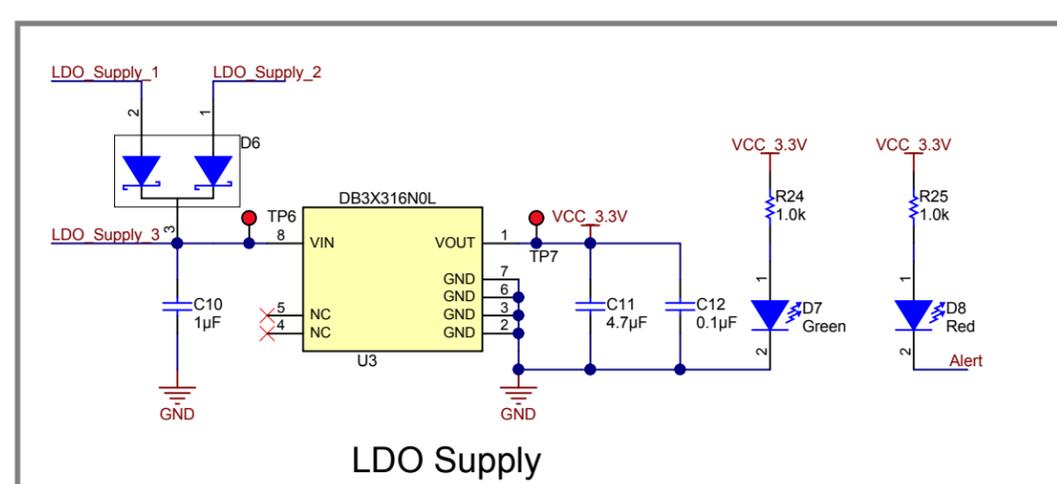
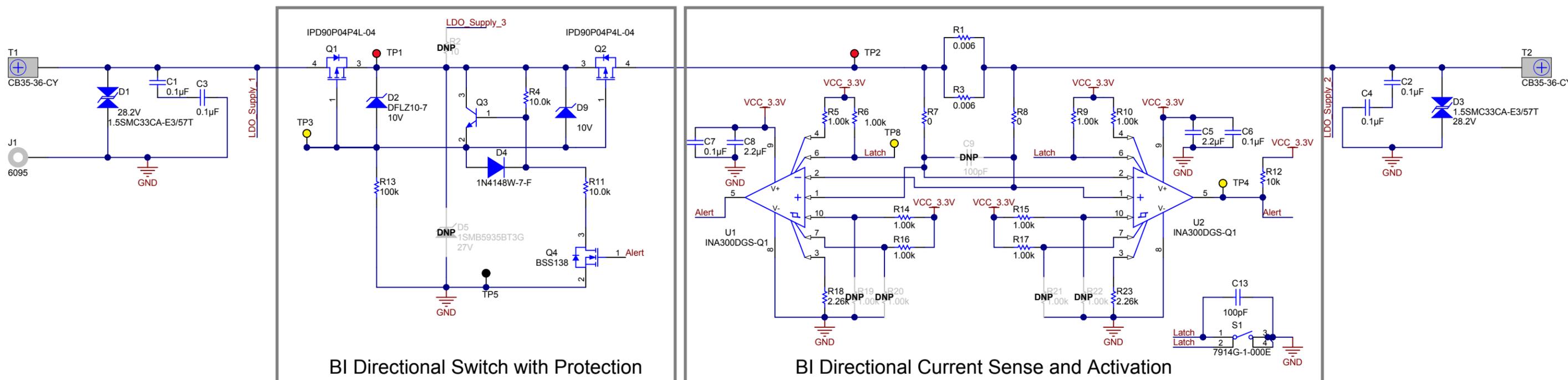


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: TIDA-00795	Project Title: Automotive Precision E-Fuse		
Number: TIDA-00795	Rev: E1	Sheet Title: Block Diagram	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3	
Drawn By: Rama Kambham	File: TIDA-00795_BlockDiagram.SchDoc	Size: B	
Engineer: Rama Kambham	Contact: http://www.ti.com/support		



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TID #: TIDA-00795	Project Title: Automotive Precision E-Fuse	
Number: TIDA-00795	Rev: E1	Sheet Title: E-Fuse
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Rama Kambham	File: TIDA-00795_Schematic.SchDoc	Size: B
Engineer: Rama Kambham	Contact: http://www.ti.com/support	





TIDA-00795
 PCB Number: TIDA-00795
 PCB Rev: E1

PCB LOGO
 Texas Instruments
 PCB LOGO
 Pb-Free Symbol
 PCB LOGO
 FCC disclaimer

LBL1
 PCB Label
 Size: 0.65" x 0.20"

ZZ1
 Label Assembly Note
 This Assembly Note is for PCB labels only

ZZ2
 Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
 Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
 Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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TID #: TIDA-00795	Project Title: Automotive Precision E-Fuse		
Number: TIDA-00795	Rev: E1	Sheet: 3 of 3	
SVN Rev: Version control disabled	Assembly Variant: 001	Size: B	
Drawn By: Rama Kambham	File: TIDA-00795_Hardware.SchDoc	Contact: http://www.ti.com/support	

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